

4M-Bit (512Kx8 /256Kx16) CMOS MASK ROM**FEATURES**

- Switchable organization
524,288 x 8(byte mode)
262,144 x 16(word mode)
- Fast access time : 80ns(Max.)
- Supply voltage : single +5V
- Current consumption
Operating : 50mA(Max.)
Standby : 50μA(Max.)
- Fully static operation
- All inputs and outputs TTL compatible
- Three state outputs
- Package
 - KM23C4100D : 40-DIP-600
 - KM23C4100DG : 40-SOP-525

GENERAL DESCRIPTION

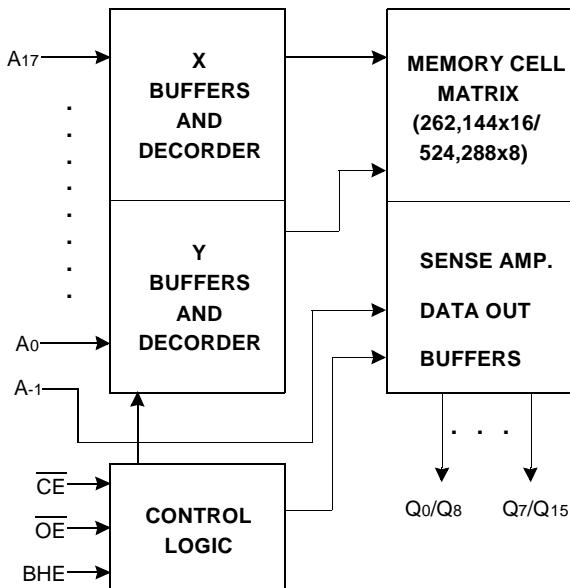
The KM23C4100D(G) is a fully static mask programmable ROM fabricated using silicon gate CMOS process technology, and is organized either as 524,288 x 8 bit(byte mode) or as 262,144 x 16 bit(word mode) depending on BHE voltage level.(See mode selection table)

This device operates with a 5V single power supply, and all inputs and outputs are TTL compatible.

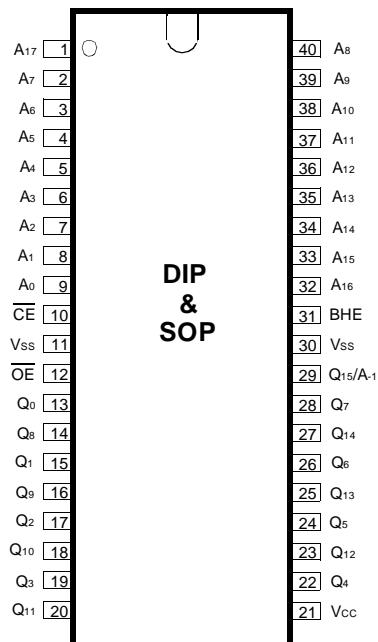
Because of its asynchronous operation, it requires no external clock assuring extremely easy operation.

It is suitable for use in program memory of microprocessor, and data memory, character generator.

The KM23C4100D is packaged in a 40-DIP and the KM23C4100DG in a 40-SOP.

FUNCTIONAL BLOCK DIAGRAM

Pin Name	Pin Function
A0 - A17	Address Inputs
Q0 - Q14	Data Outputs
Q15 /A-1	Output 15(Word mode)/ LSB Address(Byte mode)
BHE	Word/Byte selection
CE	Chip Enable
OE	Output Enable
Vcc	Power(+5.0V)
Vss	Ground

PIN CONFIGURATION

KM23C4100D(G)



ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Rating	Unit
Voltage on Any Pin Relative to Vss	VIN	-0.3 to +7.0	V
Temperature Under Bias	TBIAS	-10 to +85	°C
Storage Temperature	TSTG	-55 to +150	°C

NOTE : Permanent device damage may occur if "ABSOLUTE MAXIMUM RATINGS" are exceeded. Functional operation should be restricted to conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS (Voltage reference to Vss, TA=0 to 70°C)

Item	Symbol	Min	Typ	Max	Unit
Supply Voltage	Vcc	4.5	5.0	5.5	V
Supply Voltage	Vss	0	0	0	V

DC CHARACTERISTICS

Parameter	Symbol	Test Conditions	Min	Max	Unit
Operating Current	Icc	$\overline{CE}=\overline{OE}=VIL$, all outputs open	-	50	mA
Standby Current(TTL)	ISB1	$\overline{CE}=VIH$, all outputs open	-	1	mA
Standby Current(CMOS)	ISB2	$\overline{CE}=Vcc$, all outputs open	-	50	μA
Input Leakage Current	ILI	$VIN=0$ to Vcc	-	10	μA
Output Leakage Current	ILO	$VOUT=0$ to Vcc	-	10	μA
Input High Voltage, All Inputs	VIH		2.2	$Vcc+0.3$	V
Input Low Voltage, All Inputs	VIL		-0.3	0.8	V
Output High Voltage Level	VOH	$I_{OH}=-400\mu A$	2.4	-	V
Output Low Voltage Level	VOI	$I_{OL}=2.1mA$	-	0.4	V

NOTE : Minimum DC Voltage(VIL) is -0.3V an input pins. During transitions, this level may undershoot to -2.0V for periods <20ns.

Maximum DC voltage on input pins(VIH) is $Vcc+0.3V$ which, during transitions, may overshoot to $Vcc+2.0V$ for periods <20ns.

MODE SELECTION

CE	OE	Mode	Data	Power
H	X	Standby	High-Z	Standby
L	H	Operating	High-Z	Active
	L	Operating	Dout	Active

CAPACITANCE (TA=25°C, f=1.0MHz)

Item	Symbol	Test Conditions	MIN	Max	Unit
Output Capacitance	COUT	$VOUT=0V$	-	10	pF
Input Capacitance	CIN	$VIN=0V$	-	10	pF

NOTE : Capacitance is periodically sampled and not 100% tested.



AC CHARACTERISTICS ($T_A=0^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{CC}=5\text{V}\pm10\%$, unless otherwise noted.)

TEST CONDITIONS

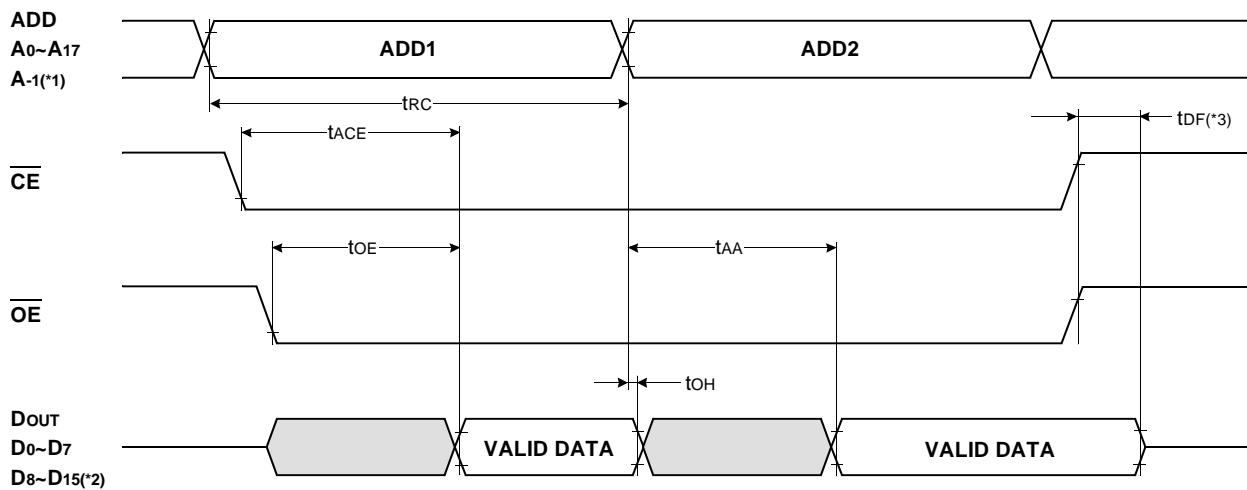
Item	Value
Input Pulse Levels	0.6V to 2.4V
Input Rise and Fall Times	10ns
Input and Output timing Levels	0.8V and 2.0V
Output Loads	1 TTL Gate and $C_L=100\text{pF}$

READ CYCLE

Item	Symbol	KM23C4100D(G)-8		KM23C4100D(G)-10		KM23C4100D(G)-12		Unit
		Min	Max	Min	Max	Min	Max	
Read Cycle Time	t _{RC}	80		100		120		ns
Chip Enable Access Time	t _{ACE}		80		100		120	ns
Address Access Time	t _{AA}		80		100		120	ns
Output Enable Access Time	t _{OE}		40		50		60	ns
Output or Chip Disable to Output High-Z	t _{DF}		20		20		20	ns
Output Hold from Address Change	t _{OH}	0		0		0		ns

TIMING DIAGRAM

READ



NOTES :

*1. Byte Mode only. A₁ is Least Significant Bit Address.(BHE = V_{IL})

*2. Word Mode only.(BHE = V_{IH})

*3. t_{DF} is defined as the time at which the outputs achieve the open circuit condition and is not referenced to V_H or V_{OL} level.



ELECTRONICS

PACKAGE DIMENSIONS

Unit : mm/inch

